

## Features

- RoHS compliant\*
- Low power loss and high efficiency
- High current capability
- Low profile package

## Applications

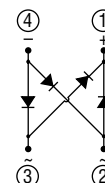
- AC operated products
- Computer monitors
- Set-top boxes
- Cable modems

## CD-MBL2xxS(L) Series Surface Mount Bridge Rectifier Diode

### General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components.

Bourns offers Bridge Rectifier Diodes for rectification applications in compact chip package 0.23 " x 0.20 " size format, which offers PCB real estate savings and are considerably smaller than standard parts. The Bridge Rectifier Diodes offer a forward current of 2 A with a choice of repetitive peak reverse voltages between 600 V and 1000 V.



### Absolute Maximum Ratings (@ $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	CD-						Unit
		MBL206S	MBL208S	MBL210S	MBL206SL	MBL208SL	MBL210SL	
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	600	800	1000	600	800	1000	V
Maximum Average Forward Rectified Current (T <sub>A</sub> = 55 °C)	I <sub>F(AV)</sub>	2.0						A
Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Superimposed on Rated Load (JEDEC Method)	I <sub>FSM</sub>	50.0			60.0			A
Operating Temperature Range	T <sub>J</sub>	-55 to +175						°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +175						°C

### Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	CD-MBL2xxS(L)					Unit
		Test Conditions		Min.	Typ.	Max.	
Instantaneous Forward Voltage	$V_F$	$I_F = 2\text{ A}$	CD-MBL2xxS		0.95	1.0	V
			CD-MBL2xxSL		0.94	0.96	
Repetitive Peak Reverse Current	$I_{RRM}$	$V_R = V_{RRM}$	$T_A = +25^\circ\text{C}$		0.08	5.0	$\mu\text{A}$
Junction Capacitance	$C_J$	$V_R = 4\text{ V}$ $f = 1.0\text{ MHz}$	CD-MBL2xxS		25		pF
			CD-MBL2xxSL		35		
Thermal Resistance, Junction to Air <sup>(1)</sup>	$R_{\theta JA}$	CD-MBL2xxS			95		$^\circ\text{C} / \text{W}$
		CD-MBL2xxSL			95		
Thermal Resistance, Junction to Lead <sup>(1)</sup>	$R_{\theta JL}$	CD-MBL2xxS			15		$^\circ\text{C} / \text{W}$
		CD-MBL2xxSL			15		

NOTE 1: Measured when mounted on PCB with 5.0 mm x 5.0 mm (0.2 " x 0.2 ") copper pad areas.

\*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

Specifications are subject to change without notice.

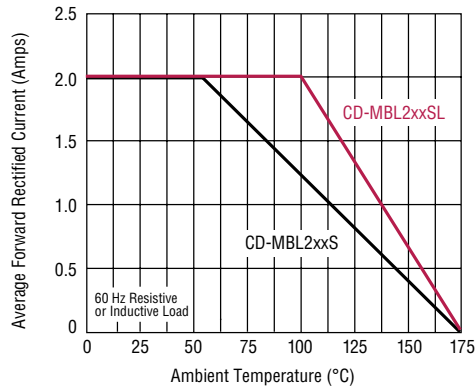
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.

# CD-MBL2xxS(L) Series Surface Mount Bridge Rectifier Diode

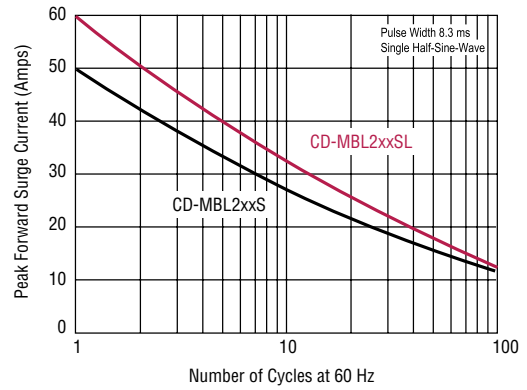
**BOURNS®**

## Rating and Characteristic Curves

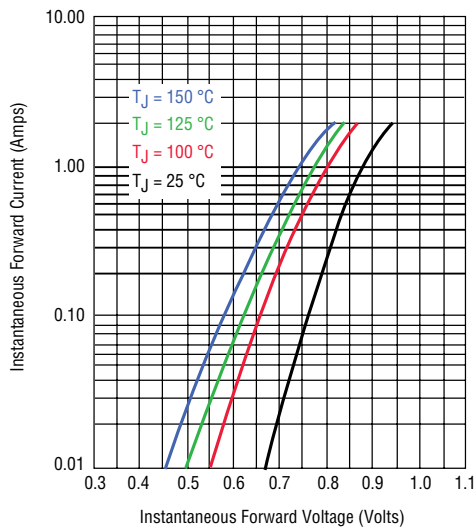
### Forward Current Derating Curve



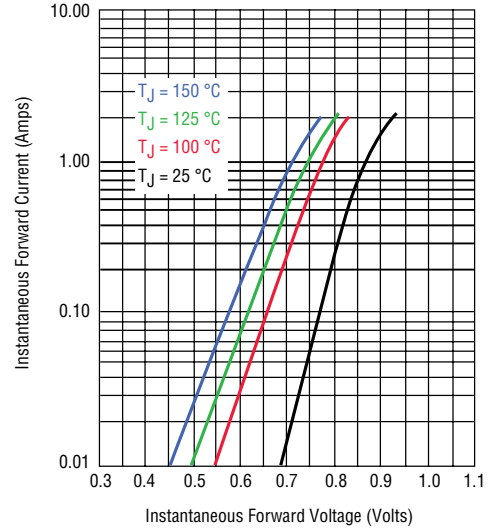
### Maximum Non-Repetitive Peak Forward Surge Current



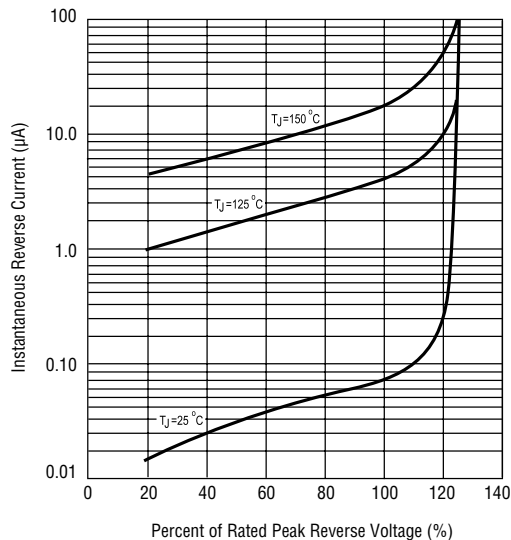
### Forward Characteristics (CD2320-B2xxx)



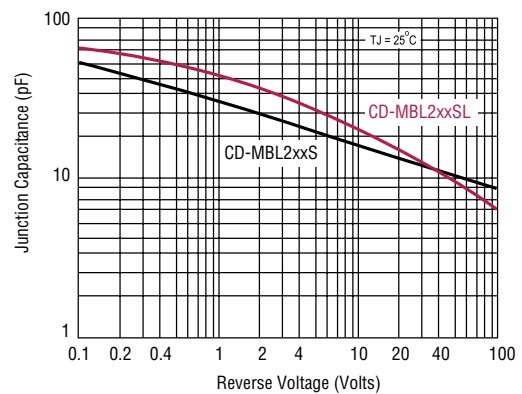
### Forward Characteristics (CD-MBL2xxS(L))



### Reverse Characteristics



### Typical Junction Capacitance



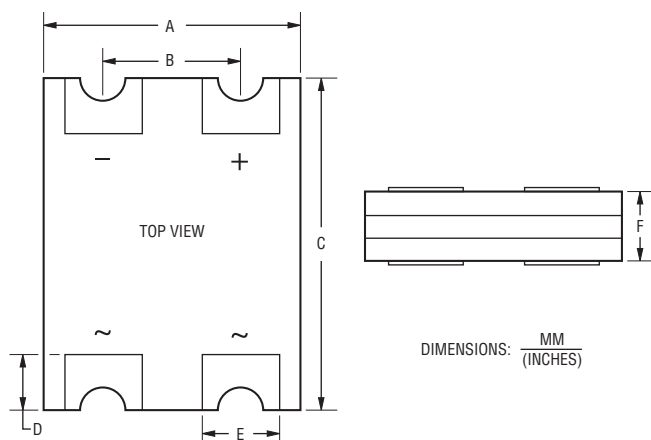
Specifications are subject to change without notice. The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.

# CD-MBL2xxS(L) Series Surface Mount Bridge Rectifier Diode

**BOURNS®**

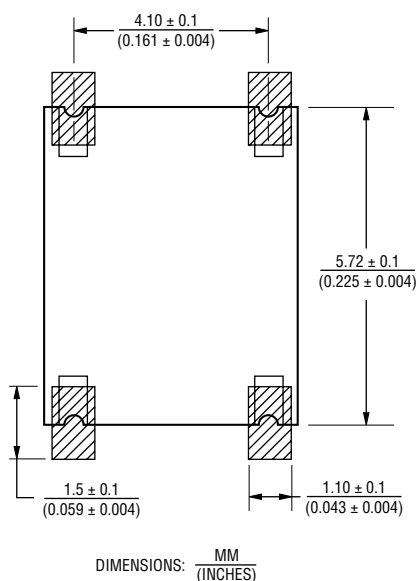
## Product Dimensions

This is an RoHS2 compliant product, packaged with FRP substrate and is epoxy underfilled. The terminals are pure tin plated (lead free) and are solderable per MIL-STD-750, Method 2026. The package and dimensions are shown below.



Dimensions	
A	$\frac{5.20 - 5.40}{(0.205 - 0.213)}$
B	$\frac{4.10 - 4.30}{(0.161 - 0.169)}$
C	$\frac{5.70 - 5.90}{(0.224 - 0.232)}$
D	$\frac{1.00 - 1.20}{(0.039 - 0.047)}$
E	$\frac{0.85 - 0.95}{(0.033 - 0.037)}$
F	$\frac{1.05 - 1.35}{(0.0413 - 0.0531)}$

## Recommended Footprint



## How to Order

**CD - MBL 2 06 SL**

Common Code \_\_\_\_\_

Chip Diode \_\_\_\_\_

Model \_\_\_\_\_

MBL = MBL Bridge Series

Average Forward Current \_\_\_\_\_

2 = 2 A

Reverse Voltage \_\_\_\_\_

06 = 600 V

08 = 800 V

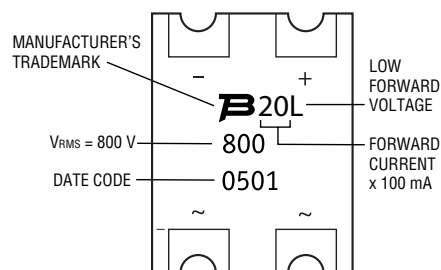
10 = 1000 V

Forward Voltage Suffix \_\_\_\_\_

S = Standard Forward Voltage

SL = Low Forward Voltage

## Typical Part Marking



Specifications are subject to change without notice.

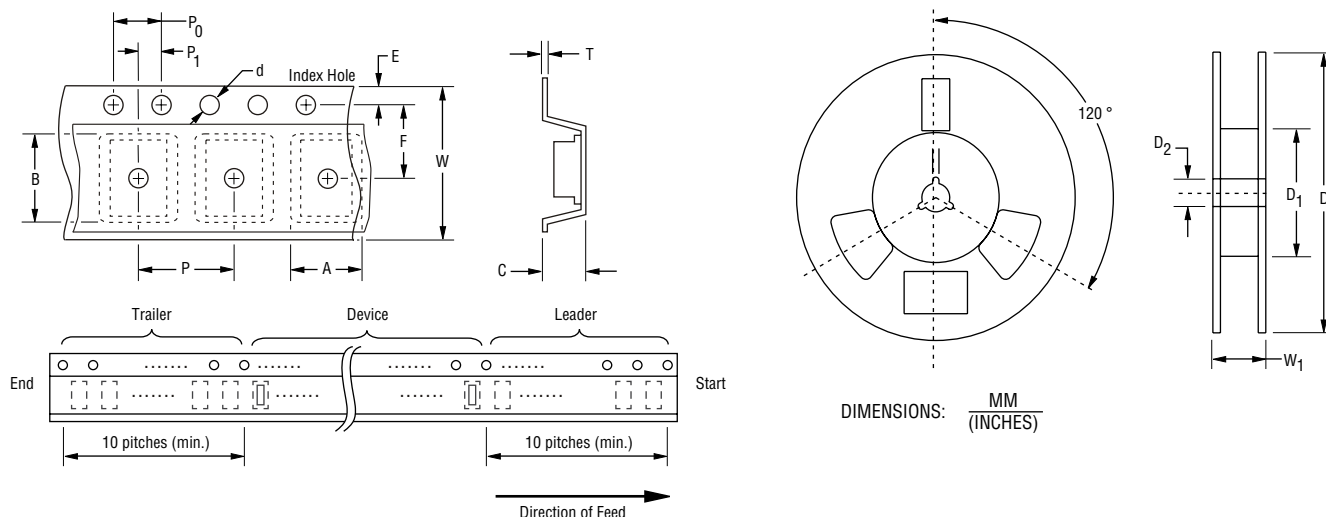
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.

# CD-MBL2xxS(L) Series Surface Mount Bridge Rectifier Diode

**BOURNS®**

## Packaging Information

The surface mount product is packaged in a 12 mm x 8 mm tape and reel format per EIA-481 standard.



Item	Symbol	CD-MBL2xxS(L)
Carrier Width	A	$\frac{5.90 \pm 0.10}{(0.232 \pm 0.004)}$
Carrier Length	B	$\frac{6.50 \pm 0.10}{(0.256 \pm 0.004)}$
Carrier Depth	C	$\frac{1.50 \pm 0.10}{(0.059 \pm 0.004)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.05}{(0.061 \pm 0.002)}$
Reel Outside Diameter	D	$\frac{330}{(12.992)}$
Reel Inner Diameter	D <sub>1</sub>	$\frac{50.0}{(1.969)} \text{ MIN.}$
Feed Hole Diameter	D <sub>2</sub>	$\frac{13.0 \pm 0.20}{(0.512 \pm 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
Punch Hole Position	F	$\frac{5.50 \pm 0.05}{(0.217 \pm 0.002)}$
Punch Hole Pitch	P	$\frac{8.00 \pm 0.10}{(0.315 \pm 0.004)}$
Sprocket Hole Pitch	P <sub>0</sub>	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Embossment Center	P <sub>1</sub>	$\frac{2.00 \pm 0.05}{(0.079 \pm 0.002)}$
Overall Tape Thickness	T	$\frac{0.20 \pm 0.10}{(0.008 \pm 0.004)}$
Tape Width	W	$\frac{12.00 \pm 0.20}{(0.472 \pm 0.008)}$
Reel Width	W <sub>1</sub>	$\frac{18.7}{(0.736)} \text{ MAX.}$
Quantity per Reel	--	5,000

**BOURNS®**

### Asia-Pacific:

Tel: +886-2 2562-4117

Email: asiacus@bourns.com

### Europe:

Tel: +36 88 520 390

Email: eurocus@bourns.com

### The Americas:

Tel: +1-951 781-5500

Email: americus@bourns.com

**www.bourns.com**

REV. 02/17

Specifications are subject to change without notice.  
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.  
Users should verify actual device performance in their specific applications.